

Prosperity Dielectrics Co., Ltd.

No.566-1, Kaoshi Rd., Yangmei, Taoyuan 32668, Taiwan (R.O.C.)

Tel : 886-3-4753355

Fax : 886-3-4854959

Messrs. : 一般共用

Date : 2019/11/11

APPROVAL SHEET

Product Name : Medium Voltage Multilayer Ceramic Chip Capacitors

Part No. : FM Series

Description : Size 0402~2225, C0G/X7R/Y5V, 100Vdc~630Vdc

PREPARED BY	APPROVED BY

信昌電子陶瓷股份有限公司

PROSPERITY DIELECTRICS CO., LTD.

桃園市楊梅區高獅路 566-1 號 <http://www.pdc.com.tw>

Tel : 03-4753355 ext :

Fax : 03-4854959

Contactor : _____ **Mobile :** _____

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SPECIFICATION

FOR

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SPEC. No. : FM-000-001-18

DATE : 2019/11/11

DRAWN BY	CHECEKED BY	APPROVED BY
<i>Jane Hsiao</i>	<i>Yvens Chou</i>	<i>Joseph Ling</i>

1. INTRODUCTION

FM Series green type capacitors are manufactured by using green materials without lead and cadmium. These capacitors feature series connection of multi-layer capacitor units in a MLCC to realize high voltage performance. Reliable performances are built-in through exact formulation of dielectric powders, preparation of conductive paste, advanced automatic manufacturing, and strict quality control to assure excellent control in dielectric thickness, electrode integrity, and electrode-to-termination continuity.

2. FEATURES

- Medium voltage in a given case size.
- High reliability and stability.
- RoHS compliant.

3. APPLICATIONS

- DC to DC converter.
- High voltage coupling/DC blocking.
- Back-lighting inverters.
- Snubbers in high frequency power converters.

4. HOW TO ORDER

<u>FM</u>	<u>31</u>	<u>X</u>	<u>471</u>	<u>K</u>	<u>251</u>	<u>P</u>	<u>X</u>	<u>G</u>
PDC Family	Size	Dielectric	Capacitance	Tolerance	Rated Voltage	Packaging	Thickness	Control Code
Table 1	Table 2	Table 3	Table 4	Table 5	Table 6	Table 7	Table 8	Table 9

Table 1	PDC Family
Code	Description
FM	100V≤Rated Voltage≤630V series

Table 2		Size			
Code	Description	Code	Description	Code	Description
15	0402 (1005)	32	1210 (3225)	52	2211 (5728)
18	0603 (1608)	42	1808 (4520)	55	2220 (5750)
21	0805 (2012)	43	1812 (4532)	56	2225 (5763)
31	1206 (3216)	46	1825 (4563)		

Table 3		Dielectric Material Characteristics	
Code	Description	Code	Description
N	C0G	X	X7R
F	Y5V		

Table 4		Capacitance Rule Code	
Code	Description	Code	Description
R47	0.47pF	102	102=10x10 ² =1000pF
0R5	0.5pF	104	104=10x10 ⁴ =100nF
100	100=10x10 ⁰ =10pF	106	106=10x10 ⁶ =10μF

Table 5		Tolerance			
Code	Description	Code	Description	Code	Description
A	±0.05 pF	J	±5 %	X	+10%~+20%
B	±0.10 pF	K	±10 %		
C	±0.25 pF	L	0% ~ +10%		
D	±0.50 pF	M	±20 %		
F	±1 %	N	-5% ~ +10%		
G	±2 %	P	±0.02 pF		
H	±3 %	Q	±0.03 pF		
I	-10% ~ 0%	Z	-20% ~ +80%		

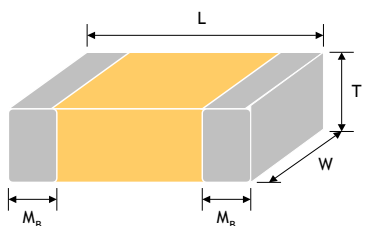
Table 6		Rated Voltage			
Code	Description	Code	Description	Code	Description
101	100Vdc	251	250Vdc	501	500Vdc
201	200Vdc	401	400Vdc	631	630Vdc

Table 7		Packaging Type	
Code	Description	Code	Description
B	Bulk	T	Tray package
E	Tape and 7" Reel, Embossed Tape	P	Tape and 7" Reel, Paper Tape
K	Tape and 10" Reel, Embossed Tape	D	Tape and 10" Reel, Paper Tape
L	Tape and 13" Reel, Embossed Tape	G	Tape and 13" Reel, Paper Tape

Table 8		Thickness Description			
Code	Description	Code	Description	Code	Description
A	0.60 ± 0.10 mm	I	1.25 ± 0.20 mm	Q	0.50 +0.02/-0.05 mm
B	0.8 + 0.15/-0.10 mm	J	1.15 ± 0.15 mm	R	3.10 ± 0.30 mm
C	1.25 ± 0.10 mm	K	0.50 ± 0.20 mm	S	0.80 ± 0.07 mm
D	1.40 ± 0.15 mm	L	0.30 ± 0.03 mm	T	0.85 ± 0.10 mm
E	1.60 ± 0.20 mm	M	0.95 ± 0.10 mm	U	0.50 ± 0.10 mm
F	2.00 ± 0.20 mm	N	0.50 ± 0.05 mm	V	0.20 ± 0.02 mm
G	2.50 ± 0.30 mm	O	3.50 ± 0.20 mm	X	0.80 ± 0.10 mm
H	2.80 ± 0.30 mm	P	1.60 +0.3/-0.10 mm	Z	0.25 ± 0.03 mm

Table 9	Special Control Code
Code	Description
G	RoHS Compliant
Q	Surface Coating (Size 1206~2225)

5. EXTERNAL DIMENSIONS

Size Inch (mm)	L (mm)	W (mm)	Code / T (mm)	M _B (mm)	
0402(1005)	1.00±0.10	0.50±0.10	See No.4 Reference Table 8	0.25 +0.05/-0.10	
0603(1608)	1.60±0.15	0.80±0.15		0.40±0.15	
0805(2012)	2.00±0.20	1.25±0.20		0.50±0.20	
1206(3216)	3.20±0.20 3.20 +0.30/-0.10 [#]	1.60±0.20 1.60 +0.30/-0.10 [#]		0.60±0.20	
1210(3225)	3.20±0.30	2.50±0.30		0.75±0.35	
1808(4520)	4.50±0.40	2.00±0.25		0.75±0.35	
1812(4532)	4.50±0.40	3.20±0.30		0.75±0.35	
1825(4563)	4.50±0.40	6.30±0.40		0.75±0.35	
2220(5750)	5.70±0.40	5.00±0.40		0.85±0.35	
2225(5763)	5.70±0.40	6.30±0.40		0.85±0.35	
					Fig. 5.1 The outline of MLCC

[#]For 1206 size P thickness products.

6. GENERAL ELECTRICAL DATA

Dielectric	C0G	X7R	Y5V						
Size	0402, 0603, 0805, 1206, 1210, 1808, 1812, 1825, 2220, 2225	0402, 0603, 0805, 1206, 1210, 1808, 1812, 1825, 2220, 2225	0805, 1206, 1210, 1812						
Rated voltage (WVDC)	100V, 200V, 250V, 500V, 630V	100V, 200V, 250V, 500V, 630V	100V, 200V, 250V						
Capacitance range	0.5pF ~ 100nF	100pF ~ 820nF	10nF to 680nF						
Capacitance tolerance	Reference to Table5	Reference to Table5	Reference to Table5						
Tan δ	<table><tr><th>Cap. Rang</th><th>Q Spec.</th></tr><tr><td>Cap.<30pF</td><td>Q≥400+20C</td></tr><tr><td>Cap.≥30pF</td><td>Q≥1000</td></tr></table>	Cap. Rang	Q Spec.	Cap.<30pF	Q≥400+20C	Cap.≥30pF	Q≥1000	≤2.5% ~ ≤10.0%	≤5.0%
Cap. Rang	Q Spec.								
Cap.<30pF	Q≥400+20C								
Cap.≥30pF	Q≥1000								
Capacitance & Tan δ Test condition	Measured at the condition of 30~70% related humidity								
	For 25°C at ambient temperature	Preconditioning for Class II MLCC : Perform a heat treatment at 150±10°C for 1 hour, then leave in ambient condition for 24±2 hours before measurement							
	<table><tr><th>Cap. Rang</th><th>Test Condition</th></tr><tr><td>Cap.≤1000pF</td><td>1.0±0.2Vrms, 1.0MHz±10%</td></tr><tr><td>Cap.>1000pF</td><td>1.0±0.2Vrms, 1.0KHz±10%</td></tr></table>	Cap. Rang	Test Condition	Cap.≤1000pF	1.0±0.2Vrms, 1.0MHz±10%	Cap.>1000pF	1.0±0.2Vrms, 1.0KHz±10%	1.0±0.2Vrms, 1.0KHz±10%, at 25°C ambient temperature	1.0±0.2Vrms, 1.0KHz±10%, at 20°C ambient temperature
	Cap. Rang	Test Condition							
Cap.≤1000pF	1.0±0.2Vrms, 1.0MHz±10%								
Cap.>1000pF	1.0±0.2Vrms, 1.0KHz±10%								
Insulation resistance at Ur	≥10GΩ or RxC≥500Ω-F, whichever is smaller	≥10GΩ or RxC≥100Ω-F, whichever is smaller							
Operating temperature	-55 to +125°C		-25 to +85°C						
Capacitance characteristic	±30ppm/°C	±15%	+30/-80%						
Termination	Cu or Ag/Ni/Sn or Au (lead-free termination)								

7. CAPACITANCE RANGE

7-1. C0G

Dimension		0402			0603			0805					1206				
Cap(pF)	code	100V	200V	250V	100V	200V	250V	100V	200V	250V	500V	630V	100V	200V	250V	500V	630V
0.5	0R5	N	N	N	S	S	S	A	A	A	A	A					
1.0	1R0	N	N	N	S	S	S	A	A	A	A	A					
1.2	1R2	N	N	N	S	S	S	A	A	A	A	A	X			X	
1.5	1R5	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
1.8	1R8	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
2.2	2R2	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
2.7	2R7	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
3.3	3R3	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
3.9	3R9	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
4.7	4R7	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
5.6	5R6	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
6.8	6R8	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
8.2	8R2	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
10	100	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
12	120	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
15	150	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
18	180	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
22	220	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
27	270	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
33	330	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
39	390	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
47	470	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
56	560	N	N	N	S	S	S	A	A	A	A	A	X	X	X	X	X
68	680	N	N		S	S	S	A	A	A	A	A	X	X	X	X	X
82	820	N	N		S	S	S	A	A	A	X	X	X	X	X	X	X
100	101	N	N		S	S	S	A	A	X	X	X	X	X	X	X	X
120	121	N			S	S	S	A	A	X	C	C	X	X	X	X	X
150	151	N			S	S	S	A	X	X	C	C	X	X	X	X	X
180	181	N			S	S	S	A	X	C	C	C	X	X	X	X	X
220	221	N			S	S	S	A	C	C	C	C	X	X	X	X	X
270	271				S	B	B	A	C	C	C	C	X	X	M	M	M
330	331				S	B	B	A	C	C	C	C	X	X	M	M	M
390	391				S	B	B	X	C	C	C	C	X	X	M	M	M
470	471				S	B	B	X	C	C	I	I	X	M	M	M	M
560	561				S	B	B	X	C	C	I	I	X	M	C	C	C
680	681				S			X	C	C	I	I	X	M	C	C	C
820	821				S			X	C	C	I	I	X	M	E	E	E
1000	102				S			X	C	C	I	I	X	M	E	E	E
1200	122				B			X	C	C			X	M	E	E	E
1500	152				B			X	C	C			X	C	E	E	E
1800	182							X	C	C			X	C	E	E	E
2200	222							X	C	C			M	C	E	E	E
2700	272							C	C	C			M	C	E	E	E
3300	332							C					C	C	E	E	E
3900	392							C					C	E	E	E	E
4700	472							C					C	E	E	E	E
5600	562							C					E	E	E	E	
6800	682							C					E	E	E	E	
8200	822												E	E	E		
10000	103												E	E	E		
12000	123												P				
15000	153												P				
18000	183												P				
22000	223												P				
27000	273																
33000	333																

7. CAPACITANCE RANGE

7-1. C0G

Dimension		1210					1808					1812				
Cap(pF)	code	100V	200V	250V	500V	630V	100V	200V	250V	500V	630V	100V	200V	250V	500V	630V
2.2	2R2						C	C	C	C	C					
2.7	2R7						C	C	C	C	C					
3.3	3R3						C	C	C	C	C					
3.9	3R9						C	C	C	C	C					
4.7	4R7						C	C	C	C	C					
5.6	5R6						C	C	C	C	C					
6.8	6R8						C	C	C	C	C					
8.2	8R2						C	C	C	C	C					
10	100	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
12	120	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
15	150	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
18	180	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
22	220	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
27	270	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
33	330	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
39	390	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
47	470	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
56	560	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
68	680	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
82	820	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
100	101	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
120	121	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
150	151	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
180	181	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
220	221	M	M	M	M	M	C	C	C	C	C	C	C	C	C	C
270	271	M	M	M	M	M	C	C	C	F	F	C	C	C	C	C
330	331	M	M	M	M	M	C	C	C	F	F	C	C	C	C	C
390	391	M	M	M	M	M	C	C	C	F	F	C	C	C	C	C
470	471	M	M	M	M	M	C	C	C	F	F	C	C	C	C	C
560	561	M	M	M	M	M	C	C	C	F	F	C	C	C	C	C
680	681	M	M	M	M	M	C	C	C	F	F	C	C	C	C	C
820	821	M	M	M	M	M	C	C	C	F	F	C	C	C	C	C
1000	102	M	C	C	C	C	C	C	C	F	F	C	C	C	C	C
1200	122	M	C	C	C	C	C	C	C	F	F	C	C	C	C	C
1500	152	M	C	C	C	C	C	C	C	F	F	C	C	C	C	C
1800	182	M	C	C	C	C	C	C	C	F	F	C	C	C	C	C
2200	222	M	C	C	C	C	C	C	C	F	F	C	C	C	C	C
2700	272	M	C	C	C	C	C	C	C	F	F	C	C	C	C	C
3300	332	M	C	C	C	C	C	C	C	F	F	C	C	C	C	C
3900	392	M	C	C	C	C	C	C	C			C	C	C	C	C
4700	472	M	E	E	C	C	C	C	C			C	C	C	C	C
5600	562	C	E	E	C	C	C	E	E			C	C	C	C	C
6800	682	C	E	E	E	E	C	E	E			C	C	C	C	C
8200	822	C	E	E	E	E	E	F	F			C	C	C	C	C
10000	103	E	F	F	F	F	E	F	F			C	C	C	C	C
12000	123	E	F									C	E	E	E	E
15000	153	F	G									C	E	E	E	E
18000	183	F/G	G									E	F	F	F	F
22000	223	F/G	G									E	F	F	F	F
27000	273	F										F	G	G		
33000	333	F										F				
39000	393	F										G				
47000	473	F										G				
56000	563											G				
68000	683											G				
82000	823											G				
100000	104											G				

7. CAPACITANCE RANGE

7-1. C0G

Dimension		1825					2220					2225				
Cap(pF)	code	100V	200V	250V	500V	630V	100V	200V	250V	500V	630V	100V	200V	250V	500V	630V
10	100	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
12	120	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
15	150	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
18	180	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
22	220	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
27	270	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
33	330	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
39	390	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
47	470	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
56	560	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
68	680	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
82	820	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
100	101	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
120	121	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
150	151	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
180	181	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
220	221	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
270	271	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
330	331	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
390	391	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
470	471	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
560	561	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
680	681	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
820	821	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
1000	102	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
1200	122	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
1500	152	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
1800	182	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
2200	222	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
2700	272	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
3300	332	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
3900	392	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
4700	472	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
5600	562	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
6800	682	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
8200	822	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
10000	103	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
12000	123	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
15000	153	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
18000	183	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
22000	223	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
27000	273	F	F	F	F		F	F	F	F		F	F	F	F	F
33000	333	F	F	F	F		F	F	F	F		F	F	F	F	F
39000	393	F	F	F	F		F	F	F	G		F	F	F	F	F
47000	473	F	F	F			F	G	G	G		F	F	F	F	F
56000	563	F	G	G			F	G	G			F	G	G	G	G
68000	683	F	G	G			F	G	G			F	G	G	H	H
82000	823	G					G					F	G	G	R	
100000	104	G					G					G	G	G		
120000	124															
150000	154															
180000	184															
220000	224															

7. CAPACITANCE RANGE

7-2. X7R

Dimension		0402	0603				0805					1206				
Cap(pF)	code	100V	100V	200V	250V	100V	200V	250V	500V	630V	100V	200V	250V	500V	630V	
100	101	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
120	121	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
150	151	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
180	181	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
220	221	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
270	271	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
330	331	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
390	391	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
470	471	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
560	561	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
680	681	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
820	821	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
1000	102	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
1200	122	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
1500	152	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
1800	182	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
2200	222	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
2700	272	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
3300	332	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
3900	392	N	S	B	B	X	X	X	X	X	X	C	C	C	C	
4700	472	N	S	B	B	X	X	X	C	C	X	C	C	C	C	
5600	562		S	B	B	X	X	X	C	C	X	C	C	C	C	
6800	682		S	B	B	X	X	X	C	C	X	C	C	C	C	
8200	822		S	B	B	X	X	X	C	C	X	C	C	C	C	
10000	103		S	B	B	X	C	C	C	C	X	C	C	C	C	
12000	123		B			X	C	C	C	C	X	C	C	C	C	
15000	153		B			X	C	C	C	C	X	C	C	C	C	
18000	183		B			X	C	C	C	C	X	C	C	C	C	
22000	223		B			X	C	C	C	C	X	C	C	E	E	
27000	273		B			C	C	C	C	C	X	C	C	E	E	
33000	333		B			C	C	C	C		X	E	E	E	E	
39000	393		B			C	C	C			X	E	E	E	E	
47000	473		B			C	C	C			X	E	E	E	E	
56000	563		B			C	C	C			X	E	E	E	E	
68000	683		B			C	C	C			X	E	E			
82000	823		B			C	C				C	E	E			
100000	104		B			C	C				C	E	E			
120000	124					I					C	E	E			
150000	154					I					E	E	E			
180000	184					I					E	E	E			
220000	224					I					E	E	E			
270000	274					I					E					
330000	334					I					E					
390000	394					I					E					
470000	474					I					E					
560000	564										P					
680000	684										P					
820000	824										P					

7. CAPACITANCE RANGE

7-2. X7R

Dimension		1210					1808		1812				
Cap(pF)	code	100V	200V	250V	500V	630V	500V	630V	100V	200V	250V	500V	630V
100	101												
120	121												
150	151						C	C					
180	181						C	C					
220	221	M	M	M	C	C	C	C					
270	271	M	M	M	C	C	C	C	C	C	C	C	C
330	331	M	M	M	C	C	C	C	C	C	C	C	C
390	391	M	M	M	C	C	C	C	C	C	C	C	C
470	471	M	M	M	C	C	C	C	C	C	C	C	C
560	561	M	M	M	C	C	C	C	C	C	C	C	C
680	681	M	M	M	C	C	C	C	C	C	C	C	C
820	821	M	M	M	C	C	C	C	C	C	C	C	C
1000	102	M	M	M	C	C	C	C	C	C	C	C	C
1200	122	M	M	M	C	C	C	C	C	C	C	C	C
1500	152	M	M	M	C	C	C	C	C	C	C	C	C
1800	182	M	M	M	C	C	C	C	C	C	C	C	C
2200	222	M	M	M	C	C	C	C	C	C	C	C	C
2700	272	M	M	M	C	C	C	C	C	C	C	C	C
3300	332	M	M	M	C	C	C	C	C	C	C	C	C
3900	392	M	M	M	C	C	C	C	C	C	C	C	C
4700	472	M	M	M	C	C	C	C	C	C	C	C	C
5600	562	M	M	M	C	C	F	F	C	C	C	C	C
6800	682	M	M	M	C	C	F	F	C	C	C	C	C
8200	822	M	M	M	C	C	F	F	C	C	C	C	C
10000	103	M	M	M	C	C	F	F	C	C	C	C	C
12000	123	M	M	M	C	C	F	F	C	C	C	C	C
15000	153	M	M	M	C	C	F	F	C	C	C	C	C
18000	183	M	M	M	C	C	F	F	C	C	C	C	C
22000	223	M	M	M	C	C	F	F	C	C	C	C	C
27000	273	M	M	M	E	E	F	F	C	C	C	C	C
33000	333	M	M	M	E	E	F	F	C	C	C	C	C
39000	393	M	M	M	E	E	F	F	C	C	C	C	C
47000	473	M	C	C	E	E	F	F	C	C	C	C	C
56000	563	M	C	E	E	E	F	F	C	C	C	F	F
68000	683	M	E	E	F	F	F	F	C	C	C	F	F
82000	823	M	E	E	F	F	F	F	C	C	C	F	F
100000	104	M	E	E	F	F			C	C	C	F	F
120000	124	M	E	E					C	C	C	G	G
150000	154	C	G	G					C	F	F	G	G
180000	184	C	G	G					C	F	F	G	G
220000	224	C	G	G					C	F	F	G	G
270000	274	E	G	G					C	F	F	G	
330000	334	E	G	G					C	F	F	G	
390000	394	G	G	G					C	F	F	G	
470000	474	G	G	G					F	F	F	G	
560000	564	G	G	G					F	G	G		
680000	684	G	G	G					F	G	G		
820000	824	G							F	G	G		

7. CAPACITANCE RANGE

7-2. X7R

Dimension		1825					2220					2225				
Cap(pF)	code	100V	200V	250V	500V	630V	100V	200V	250V	500V	630V	100V	200V	250V	500V	630V
1000	102	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
1200	122	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
1500	152	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
1800	182	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
2200	222	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
2700	272	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
3300	332	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
3900	392	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
4700	472	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
5600	562	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
6800	682	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
8200	822	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
10000	103	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
12000	123	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
15000	153	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
18000	183	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
22000	223	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
27000	273	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
33000	333	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
39000	393	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
47000	473	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
56000	563	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
68000	683	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
82000	823	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
100000	104	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
120000	124	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
150000	154	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
180000	184	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
220000	224	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
270000	274	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
330000	334	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
390000	394	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
470000	474	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
560000	564	F	F	F	G	G	F	F	F			F	F	F	F	F
680000	684	F	F	F			F	F	F			F	F	F		
820000	824	F	F	F			F	F	F			F	F	F		

7. CAPACITANCE RANGE

7-3. Y5V

Dimension		0805			1206			1210			1812		
Cap(μF)	code	100V	200V	250V	100V	200V	250V	100V	200V	250V	100V	200V	250V
0.010	103	B	B	B	B	B	B	C	C	C	D	D	D
0.015	153	B	B	B	B	B	B	C	C	C	D	D	D
0.022	223	B	B	B	B	B	B	C	C	C	D	D	D
0.033	333	B	B	B	B	B	B	C	C	C	D	D	D
0.047	473	B	B	B	B	B	B	C	C	C	D	D	D
0.068	683	B	B	B	B	B	B	C	C	C	D	D	D
0.10	104	B			B	B	B	C	C	C	D	D	D
0.15	154				C	C	C	C	C	C	D	D	D
0.22	224				C			C			D	D	D
0.33	334							C			D	D	D
0.47	474										D	D	D
0.68	684										D	D	D



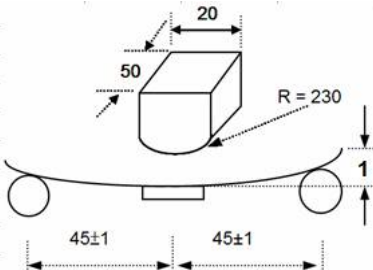
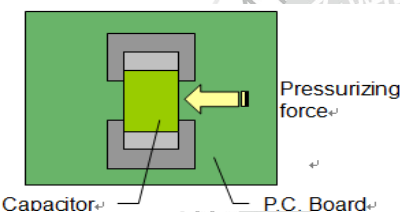
8. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Test Condition	Requirements																		
1.	Visual and Dimensions	---	* No remarkable defect. * Dimensions to confirm to individual specification sheet.																		
2.	Capacitance		* Shall not exceed the limits given in the detailed spec.																		
3.	Q/ D.F. (Tangent of loss angle)	* Class I : C0G Cap.≤1000pF, 1.0±0.2Vrms, 1MHz±10%. Cap.>1000pF, 1.0±0.2Vrms, 1KHz±10%. * Class II : (X7R, Y5V) 1.0±0.2Vrms, 1KHz±10%.	<table><tr><th>Dielectric</th><th>Q/D.F.</th><th>Remark</th></tr><tr><td rowspan="2">Class I (C0G)</td><td>Q≥1000</td><td>Cap.≥30pF</td></tr><tr><td>Q≥400+20C</td><td>Cap.<30pF</td></tr><tr><td rowspan="4">Class II</td><td>D.F.≤2.5%</td><td>X7R items</td></tr><tr><td>D.F.≤3.5%</td><td>X7R 0603≥0.047μF, 0805=0.1μF, 1206≥0.47μF</td></tr><tr><td>D.F.≤5.0%</td><td>X7R 0603≥0.068μF, 0805>0.1μF All Y5V items</td></tr><tr><td>D.F.≤10.0%</td><td>X7R 0805>0.22μF</td></tr></table>	Dielectric	Q/D.F.	Remark	Class I (C0G)	Q≥1000	Cap.≥30pF	Q≥400+20C	Cap.<30pF	Class II	D.F.≤2.5%	X7R items	D.F.≤3.5%	X7R 0603≥0.047μF, 0805=0.1μF, 1206≥0.47μF	D.F.≤5.0%	X7R 0603≥0.068μF, 0805>0.1μF All Y5V items	D.F.≤10.0%	X7R 0805>0.22μF	
			Dielectric	Q/D.F.	Remark																
			Class I (C0G)	Q≥1000	Cap.≥30pF																
				Q≥400+20C	Cap.<30pF																
			Class II	D.F.≤2.5%	X7R items																
D.F.≤3.5%	X7R 0603≥0.047μF, 0805=0.1μF, 1206≥0.47μF																				
D.F.≤5.0%	X7R 0603≥0.068μF, 0805>0.1μF All Y5V items																				
D.F.≤10.0%	X7R 0805>0.22μF																				
4.	Temperature Coefficient (Temperature characteristic of capacitance)	* With no electrical load. <table><tr><th>T.C.</th><th>Operating Temp.</th></tr><tr><td>C0G</td><td>-55~125°C at 25°C</td></tr><tr><td>X7R</td><td>-55~125°C at 25°C</td></tr><tr><td>Y5V</td><td>-25~85°C at 20°C</td></tr></table>	T.C.	Operating Temp.	C0G	-55~125°C at 25°C	X7R	-55~125°C at 25°C	Y5V	-25~85°C at 20°C	<table><tr><th>T.C.</th><th>Capacitance Change</th></tr><tr><td>C0G</td><td>Within ±30ppm/°C</td></tr><tr><td>X7R</td><td>Within ±15%</td></tr><tr><td>Y5V</td><td>Within +30%/-80%</td></tr></table>	T.C.	Capacitance Change	C0G	Within ±30ppm/°C	X7R	Within ±15%	Y5V	Within +30%/-80%		
			T.C.	Operating Temp.																	
			C0G	-55~125°C at 25°C																	
			X7R	-55~125°C at 25°C																	
			Y5V	-25~85°C at 20°C																	
T.C.	Capacitance Change																				
C0G	Within ±30ppm/°C																				
X7R	Within ±15%																				
Y5V	Within +30%/-80%																				
5.	Insulation Resistance	<table><tr><th>Rated Vol.(V)</th><th>Apply Voltage</th><th>Test Condition</th></tr><tr><td>=100</td><td>1 times of UR</td><td>Max. 120 sec.</td></tr><tr><td>200≤V≤500</td><td>1 times of UR</td><td>60 sec.</td></tr><tr><td>>500</td><td>500Vdc</td><td>60 sec.</td></tr></table>	Rated Vol.(V)	Apply Voltage	Test Condition	=100	1 times of UR	Max. 120 sec.	200≤V≤500	1 times of UR	60 sec.	>500	500Vdc	60 sec.	<table><tr><th>Dielectric</th><th>Requirements</th></tr><tr><td>Class I</td><td>≥10GΩ or RxC≥500Ω-F, whichever is smaller</td></tr><tr><td>Class II</td><td>≥10GΩ or RxC≥100Ω-F, whichever is smaller</td></tr></table>	Dielectric	Requirements	Class I	≥10GΩ or RxC≥500Ω-F, whichever is smaller	Class II	≥10GΩ or RxC≥100Ω-F, whichever is smaller
		Rated Vol.(V)	Apply Voltage	Test Condition																	
		=100	1 times of UR	Max. 120 sec.																	
		200≤V≤500	1 times of UR	60 sec.																	
>500	500Vdc	60 sec.																			
Dielectric	Requirements																				
Class I	≥10GΩ or RxC≥500Ω-F, whichever is smaller																				
Class II	≥10GΩ or RxC≥100Ω-F, whichever is smaller																				
6.	Solderability	* Solder temperature : 235±5°C for (0402~1210). * Solder temperature : 245±5°C for (1808~2225). * Dipping time : 2±0.5 sec.	* 75% min. coverage of all metalized area.																		
7.	Dielectric Strength (Voltage proof)	<table><tr><th>Rated Vol.(V)</th><th>Condition</th></tr><tr><td>≤100</td><td>2.5 times of UR</td></tr><tr><td>100<V≤250</td><td>2.0 times of UR</td></tr><tr><td>250<V≤500</td><td>1.5 times of UR</td></tr><tr><td>=630</td><td>1.2 times of UR</td></tr></table> * Duration : 1 to 5 sec. * Charge and discharge current less than 50mA.	Rated Vol.(V)	Condition	≤100	2.5 times of UR	100<V≤250	2.0 times of UR	250<V≤500	1.5 times of UR	=630	1.2 times of UR	* No evidence of damage or flashover during test.								
		Rated Vol.(V)	Condition																		
≤100	2.5 times of UR																				
100<V≤250	2.0 times of UR																				
250<V≤500	1.5 times of UR																				
=630	1.2 times of UR																				
8.	Resistance to Soldering Heat	* Solder temperature : 260±5°C. * Dipping time : 10±1 sec. * Preheating : 120 to 150°C for 1 minute before immerse the capacitor in a eutectic solder. * Before initial measurement (Class II only) : Perform 150 +0/-10°C for 1 hr and then set for 48±4 hrs at room temp. * Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).	* No remarkable damage. * Cap. Change : C0G : Within ±2.5% or ±0.25pF, whichever is larger. X7R : Within ±7.5%. Y5V : Within ±20%. * Q/D.F. & I.R. : To meet the initial requirement. * 25% max. leaching on each edge.																		
		9.	Temperature Cycle (Rapid change of temperature)	* Conduct the five cycles according to the temperatures and time. <table><tr><th>Step</th><th>Temp.(°C)</th><th>Time(min.)</th></tr><tr><td>1</td><td>Min. operating temp. +0/-3</td><td>30±3</td></tr><tr><td>2</td><td>Room temp.</td><td>2~3</td></tr><tr><td>3</td><td>Max. operating temp. +3/-0</td><td>30±3</td></tr><tr><td>4</td><td>Room temp.</td><td>2~3</td></tr></table> * Before initial measurement (Class II only) : Perform 150 +0/-10°C for 1 hr and then set for 48±4 hrs at room temp. * Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).	Step	Temp.(°C)	Time(min.)	1	Min. operating temp. +0/-3	30±3	2	Room temp.	2~3	3	Max. operating temp. +3/-0	30±3	4	Room temp.	2~3	* No remarkable damage. * Cap. change : C0G : Within ±2.5% or ±0.25pF, whichever is larger. X7R : Within ±7.5%. Y5V : Within ±20%. * Q/D.F. : C0G : To meet the initial requirement. X7R, Y5V : D.F.≤150% of initial requirement. * I.R. : To meet the initial requirement.	
Step	Temp.(°C)			Time(min.)																	
1	Min. operating temp. +0/-3			30±3																	
2	Room temp.			2~3																	
3	Max. operating temp. +3/-0			30±3																	
4	Room temp.			2~3																	

8. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Test Condition	Requirements																						
10.	Humidity (Damp Heat) Steady State	* Test temp. : 40±2°C. * Humidity : 90~95%RH. * Test time : 500 +24/-0 hrs. * Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).	* No remarkable damage. * Cap. change : C0G : Within ±5.0% or ±0.5pF, whichever is larger. X7R : Within ±12.5%. Y5V : Within ±30%. * Q/D.F. : C0G : Cap.>30pF, Q≥350; 10pF≤Cap.≤30pF, Q≥275+2.5C; Cap.<10pF, Q≥200+10C. X7R, Y5V : D.F.≤200% of initial requirement. * I.R. (Class I) : ≥10GΩ or RxC≥500Ω-F, whichever is smaller. * I.R. (Class II) : ≥1GΩ or RxC≥10Ω-F, whichever is smaller.																						
11.	Humidity (Damp Heat) Load	* Test temp. : 40±2°C. * Humidity : 90~95% RH. * Test time : 500 +24/-0hrs. * To apply voltage : Rated voltage (Max. 500Vdc). * Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).	* No remarkable damage. * Cap. change : C0G : Within ±7.5% or ±0.75pF, whichever is larger. X7R : Within ±12.5%. Y5V : Within ±30%. * Q/D.F. : C0G : Cap.≥30pF, Q≥200; Cap.<30pF, Q≥100+10/3C. X7R, Y5V : D.F.≤200% of initial requirement. * I.R. : ≥500MΩ or RxC≥25Ω-F, whichever is smaller. X7R 100V : ≥500MΩ or RxC≥5Ω-F, whichever is smaller.																						
12.	High Temperature Load (Endurance)	* Test temp. : C0G, X7R : 125±3°C. Y5V : 85±3°C. <table border="1"><thead><tr><th>Dielectric</th><th>Rated Vol.(V)</th><th>Apply Voltage</th></tr></thead><tbody><tr><td>C0G</td><td>≤100</td><td>2.0 times of UR</td></tr><tr><td>X7R</td><td>200≤V≤500</td><td>1.5 times of UR</td></tr><tr><td>Y5V</td><td>=630</td><td>1.2 times of UR</td></tr></tbody></table> * Exception items : <table border="1"><thead><tr><th>Rated Vol.(V)</th><th>Size</th><th>Cap. Range</th><th>Apply Voltage</th></tr></thead><tbody><tr><td rowspan="2">100</td><td>0603</td><td>≥0.082μF</td><td rowspan="2">2.0 times of UR</td></tr><tr><td>0805</td><td>≥0.12μF</td></tr></tbody></table> * Test time : 1000 +24/-0 hrs. * Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).	Dielectric	Rated Vol.(V)	Apply Voltage	C0G	≤100	2.0 times of UR	X7R	200≤V≤500	1.5 times of UR	Y5V	=630	1.2 times of UR	Rated Vol.(V)	Size	Cap. Range	Apply Voltage	100	0603	≥0.082μF	2.0 times of UR	0805	≥0.12μF	* No remarkable damage. * Cap. change : C0G : Within ±3.0% or ±0.3pF, whichever is larger. X7R : Within ±12.5%. Y5V : Within ±30%. * Q/D.F. : C0G : Cap.>30pF, Q≥350; 10pF≤Cap.≤30pF, Q≥275+2.5C; Cap.<10pF, Q≥200+10C. X7R, Y5V : D.F.≤200% of initial requirement. * I.R. : ≥1GΩ or RxC≥50Ω-F, whichever is smaller. X7R 100V : ≥1GΩ or RxC≥10Ω-F, whichever is smaller.
Dielectric	Rated Vol.(V)	Apply Voltage																							
C0G	≤100	2.0 times of UR																							
X7R	200≤V≤500	1.5 times of UR																							
Y5V	=630	1.2 times of UR																							
Rated Vol.(V)	Size	Cap. Range	Apply Voltage																						
100	0603	≥0.082μF	2.0 times of UR																						
	0805	≥0.12μF																							

8. RELIABILITY TEST CONDITIONS AND REQUIREMENTS

No.	Item	Test Condition	Requirements								
13	Resistance to Flexure of Substrate (Substrate bending test)	* The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1mm per second until the deflection becomes 1mm.  Unit : mm	* No remarkable damage. <table><tr><th>Dielectric</th><th>Cap. Change</th></tr><tr><td>Class I (C0G)</td><td>Within ±3.0% or ±2.0pF, whichever is larger</td></tr><tr><td>Class II (X7R)</td><td>Within ±12.5%</td></tr><tr><td>Class II (Y5V)</td><td>Within ±30%</td></tr></table> (This capacitance change means the change of capacitance under specified flexure of substrate from the capacitance measured before the test)	Dielectric	Cap. Change	Class I (C0G)	Within ±3.0% or ±2.0pF, whichever is larger	Class II (X7R)	Within ±12.5%	Class II (Y5V)	Within ±30%
Dielectric	Cap. Change										
Class I (C0G)	Within ±3.0% or ±2.0pF, whichever is larger										
Class II (X7R)	Within ±12.5%										
Class II (Y5V)	Within ±30%										
14.	Adhesive Strength of Termination (Robustness of termination)	* Capacitors mounted on a substrate. A force of 5N(≤0603) or 10N(>0603) applied perpendicular to the place of substrate and parallel the line joining the center of terminations for 10±1 second.  Capacitor, P.C. Board, Pressurizing force	* No remarkable damage or removal of the terminations.								
15.	Vibration Resistance	* Vibration frequency : 10~55 Hz/min. * Total amplitude : 1.5mm. * Test time : 6 hrs. (Two hrs each in three mutually perpendicular directions) * Measurement to be made after keeping at room temp. for 24±2 hrs (Class I) or 48±4 hrs (Class II).	* No remarkable damage. * Cap. change and Q/D.F. : To meet the initial spec.								

9. PACKAGE DIMENSION AND QUANTITY

Size	Thickness (mm)	Paper tape		Plastic tape	
		7" reel	13" reel	7" reel	13" reel
0201(0603)	0.30±0.03	15k	70k	-	-
	0.30±0.05	15k	-	-	-
	0.30±0.09	15k	-	-	-
0402(1005)	0.50±0.05	10k	50k	-	-
	0.50 +0.02/-0.05	10k	50k	-	-
	0.50±0.20	10k	-	-	-
0603(1608)	0.50±0.10	4k	-	-	-
	0.80±0.07	4k	15k	-	-
	0.80 +0.15/-0.10	4k	15k	-	-
0805(2012)	0.50±0.10	4k	15k	-	-
	0.60±0.10	4k	15k	-	-
	0.80±0.10	4k	15k	-	-
	0.85±0.10	4k	15k	-	-
	1.25±0.10	-	-	3k	10k
1206(3216)	1.25±0.20	-	-	3k	10k
	0.80±0.10	4k	15k	-	-
	0.85±0.10	4k	15k	-	-
	0.95±0.10	-	-	3k	10k
	1.15±0.15	-	-	3k	10k
	1.25±0.10	-	-	3k	10k
	1.60±0.20	-	-	2k	10k
1210(3225)	1.60 +0.30/-0.10	-	-	2k	9k
	0.85±0.10	-	-	3k	10k
	0.95±0.10	-	-	3k	10k
	1.25±0.10	-	-	3k	10k
	1.60±0.20	-	-	2k	-
	2.00±0.20	-	-	1k	6k
1808(4520)	2.50±0.30	-	-	1k	6k
	1.25±0.10	-	-	2k	10k
	1.60±0.20	-	-	2k	8k
	2.00±0.20	-	-	1k	6k
1812(4532)	1.25±0.10	-	-	1k	5k
	1.60±0.20	-	-	1k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	3k
1825(4563)	2.80±0.30	-	-	0.5k	-
	1.60±0.20	-	-	1k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	-
2220(5750)	2.80±0.30	-	-	0.5k	-
	1.60±0.20	-	-	1k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	-
2225(5763)	2.80±0.30	-	-	0.5k	-
	1.60±0.20	-	-	1k	-
	2.00±0.20	-	-	1k	-
	2.50±0.30	-	-	0.5k	-

Unit : pcs

9. PACKAGE DIMENSION AND QUANTITY

9.1. EMBOSSED TAPE DIMENSIONS

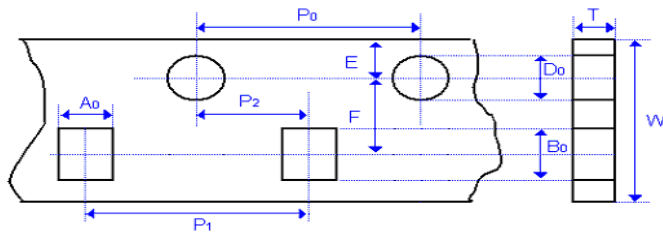


Fig. 9.1 The dimension of paper tape

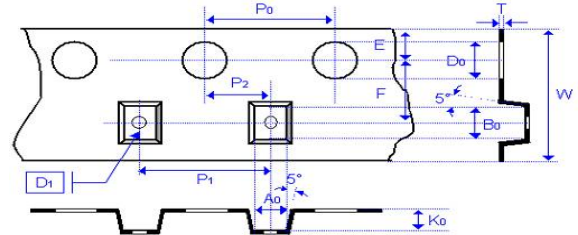


Fig. 9.2 The dimension of plastic tape

Size	0201	0402	0603		0805	
Chip Thickness	0.30±0.03	0.50±0.05 0.50±0.10	0.80±0.07	0.80 +0.15/-0.1	0.80±0.10	1.25±0.10 1.25±0.20
A ₀	0.39±0.07	0.70±0.20	1.00 +0.05/-0.10	1.02 +0.05/-0.10	1.50±0.10	<1.65
B ₀	0.69±0.07	1.20±0.20	1.80±0.10	1.80±0.10	2.30±0.10	<2.40
T	≤0.50	≤0.80	0.95±0.05	0.97±0.05	0.95±0.05	0.23±0.05
K ₀	-	-	-	-	-	<2.50
W	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10
P ₀	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
10xP ₀	40.00±0.10	40.00±0.10	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20
P ₁	2.00±0.05	2.00±0.05	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
P ₂	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05
D ₀	1.55±0.05	1.55±0.05	1.55±0.05	1.55±0.05	1.55±0.05	1.50 +0.10/-0
D ₁	-	-	-	-	-	1.00±0.10
E	1.75±0.05	1.75±0.05	1.75±0.05	1.75±0.05	1.75±0.05	1.75±0.10
F	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05
Unit :	mm	mm	mm	mm	mm	mm

Size	1206			1210		1808	
Chip Thickness	0.80±0.10	0.95±0.10 1.25±0.10	1.60±0.20 1.60+0.3/-0.1	0.95±0.10 1.25±0.10 1.60±0.20	2.50±0.30	1.25±0.10 1.60±0.20	2.00±0.20
A ₀	2.00±0.10	<2.00	<2.00	<3.05	<3.10	<2.50	<2.50
B ₀	3.50±0.10	<3.60	<3.70	<3.80	<4.00	<5.30	<5.30
T	0.95±0.05	0.23±0.05	0.23±0.05	0.23±0.05	0.23±0.05	0.25±0.05	0.25±0.05
K ₀	-	<2.50	<2.50	<2.50	<3.50	<2.50	<2.50
W	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	12.00±0.20	12.00±0.20	12.00±0.20
P ₀	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
10xP ₀	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20
P ₁	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
P ₂	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05
D ₀	1.55±0.05	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0
D ₁	-	1.00±0.10	1.00±0.10	1.00±0.10	1.00±0.10	1.50±0.10	1.50±0.10
E	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10
F	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	3.50±0.05	5.50±0.05	5.50±0.05
Unit :	mm	mm	mm	mm	mm	mm	mm

9. PACKAGE DIMENSION AND QUANTITY

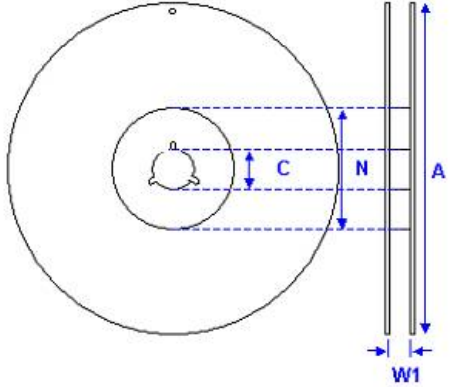
Size	1812		1825		2220	
Chip Thickness	1.25±0.10 1.60±0.20 2.00±0.20	2.50±0.30	1.60±0.20 2.00±0.20	2.50±0.30	1.40±0.15 1.60±0.20 2.00±0.20	2.50±0.30
A ₀	<3.90	<3.90	<6.80	<6.80	<5.80	<6.80
B ₀	<5.30	<5.30	<5.30	<5.30	<6.50	<6.50
T	0.25±0.05	0.25±0.05	0.30±0.10	0.30±0.10	0.30±0.10	0.30±0.10
K ₀	<2.50	<3.00	<2.50	<3.10	<2.50	<3.10
W	12.00±0.20	12.00±0.20	12.00±0.20	12.00±0.20	12.00±0.20	12.00±0.20
P ₀	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10	4.00±0.10
10xP ₀	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20	40.00±0.20
P ₁	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10	8.00±0.10
P ₂	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05	2.00±0.05
D ₀	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0	1.50 +0.10/-0
D ₁	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10	1.50±0.10
E	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10	1.75±0.10
F	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05	5.50±0.05
Unit :	mm	mm	mm	mm	mm	mm

Size	2225	
Chip Thickness	1.60±0.20 2.00±0.20	2.50±0.30
A ₀	<6.80	<6.80
B ₀	<6.50	<6.50
T	0.30±0.10	0.30±0.10
K ₀	<2.50	<3.10
W	12.00±0.20	12.00±0.20
P ₀	4.00±0.10	4.00±0.10
10xP ₀	40.00±0.20	40.00±0.20
P ₁	8.00±0.10	8.00±0.10
P ₂	2.00±0.05	2.00±0.05
D ₀	1.50 +0.10/-0	1.50 +0.10/-0
D ₁	1.50±0.10	1.50±0.10
E	1.75±0.10	1.75±0.10
F	5.50±0.05	5.50±0.05
Unit :	mm	mm

9. PACKAGE DIMENSION AND QUANTITY

9.2. REEL DIMENSIONS

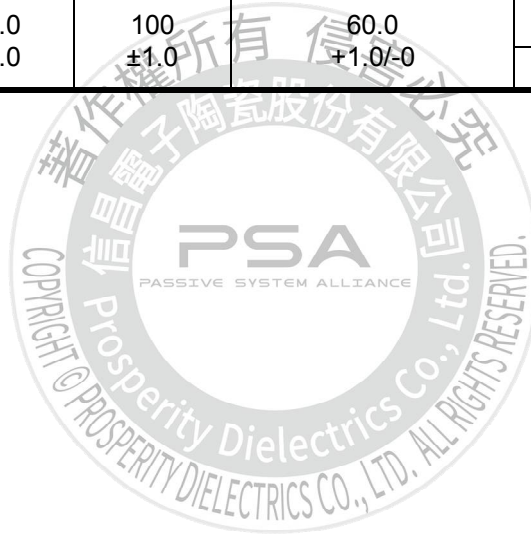
Size	0201, 0402, 0603, 0805, 1206, 1210			1808, 1812, 1825, 2220, 2225
Reel size	7"	7"	13"	7"
C	13.0 +0.5/-0.2	13.0 +0.5/-0.2	13.0 +0.7/-0.3	13.0 +0.5/-0.2
W ₁	8.4 +1.5/-0	12.4 +2.0/-0	8.4 +2.0/-0	12.4 +2.0/-0
A	178.0 ±0.10	178.0 ±0.10	330.0 ±1.0	178.0 ±0.10
N	60.0 +1.0/-0	80.0 ±1.0	100 ±1.0	60.0 +1.0/-0



The diagram illustrates the dimensions of a reel. It shows a cross-section of a reel with a central hub and a large outer circle. The dimensions are labeled as follows: C is the carrier width, N is the carrier pitch, A is the carrier height, and W1 is the carrier width at the end. The dimensions are indicated by blue arrows and dashed lines.

Fig. 9.3 The dimension of reel

Fig. 9.3 The dimension of reel



10. APPLICATION NOTES

STORAGE

To prevent the damage of solderability of terminations, the following storage conditions are recommended :
 Indoors under 5 ~ 40°C and 20% ~ 70% RH.

No harmful gases containing sulfuric acid, ammonia, hydrogen sulfide or chlorine.

Packaging should not be opened until the capacitors are required for use. If opened, the pack should be re-sealed as soon as is practicable. Taped product should be stored out of direct sunlight, which might promote deterioration in tape or adhesion performance. The product is recommended to be used within 12 months after shipment and checked the solderability before use.

HANDLING

Chip capacitors are dense, hard, brittle, and abrasive materials. They are liable to suffer mechanical damage, in the form of cracks or chips. Chip Capacitors should be handled with care to avoid contamination or damage. To use vacuum or plastic tweezers to pick up or plastic tweezers is recommended for manual placement. Tape and reeled packages are suitable for automatic pick and placement machine.

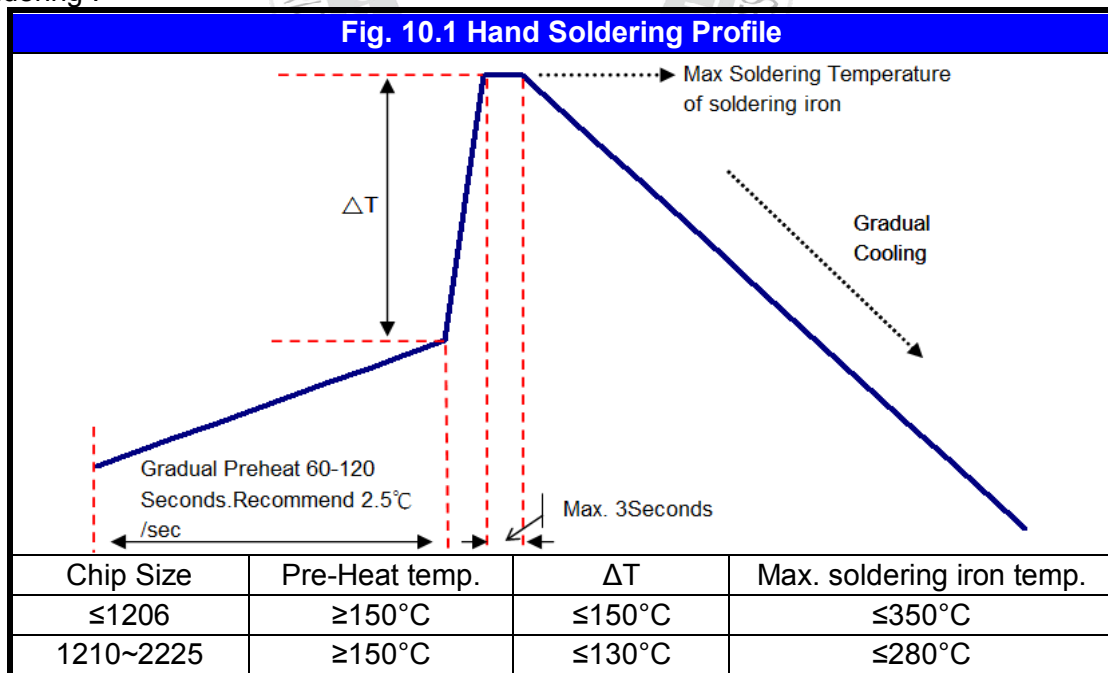
PREHEAT

In order to minimize the risk of thermal shock during soldering, a carefully controlled preheat is required. The rate of preheat should not exceed 3°C per second.

SOLDERING

Use middy activated rosin RA and RMA fluxes do not use activated flux. The amount of solder in each solder joint should be controlled to prevent the damage of chip capacitors caused by the stress between solder, chips, and substrate.

a.) Hand soldering :



* Soldering iron tip diameter ≤ 1.0 mm and wattage max. 20W.

* The Capacitors shall be pre-heated and that the temperature gradient between the devices and the tip of the soldering iron.

* The required amount of solder shall be melted on the soldering tip.

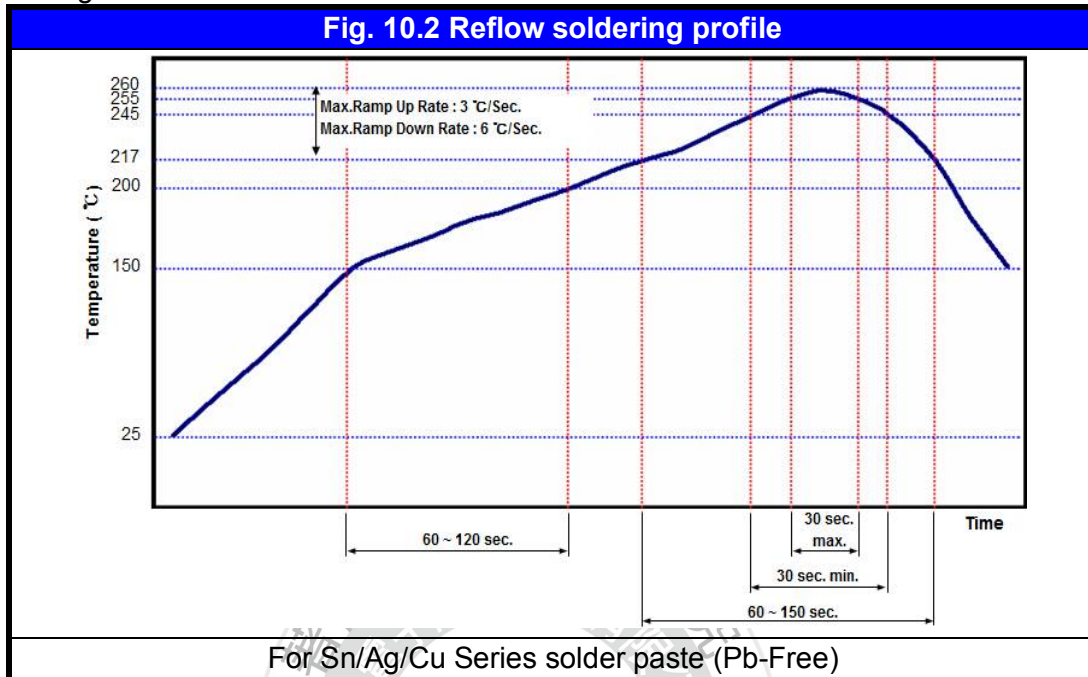
* The tip of iron should not contact the ceramic body directly.

* The Capacitors shall be cooled gradually at room temperature after soldering.

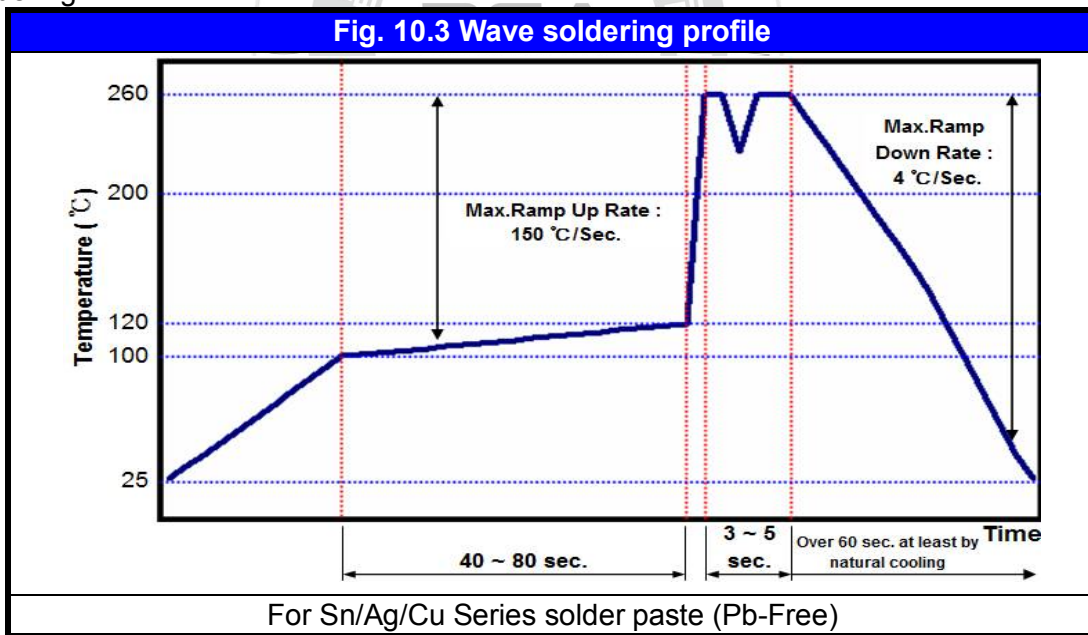
* Forced air cooling is not allowed.

10. APPLICATION NOTES

b.) Reflow soldering :



c.) Wave soldering :



Soldering conditions :

Class I :

Size Inch (mm)	Temper. Char.	Capacitance	Condition	
			Wave	Reflow
≤0402 (1005)	All Class I	All	X	O
0603 (1608)	All Class I	All	O	O
0805 (2012)	All Class I	All	O	O
1206 (3216)	All Class I	All	O	O
≥1210 (3225)	All Class I	All	X	O

10. APPLICATION NOTES

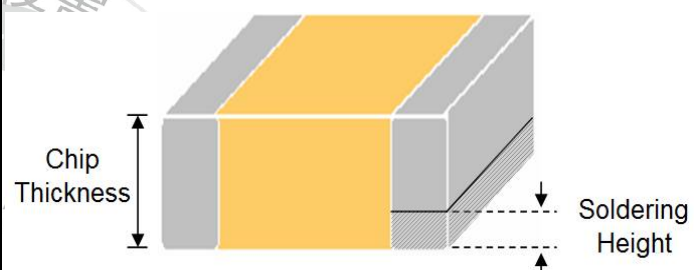
Soldering conditions :

Class II :

Size Inch (mm)	Temper. Cher.	Capacitance	Condition	
			Wave	Reflow
≤0402 (1005)	All Class II	All	X	O
0603 (1608)	All Class II	Cap. <2.2μF	O	O
		Cap. ≥2.2μF	X	O
0805 (2012)	All Class II	Cap. <4.7μF	O	O
		Cap. ≥4.7μF	X	O
1206 (3216)	All Class II	Cap. <4.7μF	O	O
		Cap. ≥4.7μF	X	O
≥1210 (3225)	All Class II	All	X	O

Soldering height :

The solder climbing minimum height is suggesting to 25% of chip thickness or 500um whichever is less.
 (Reference from IPC-610E)



COOLING

After soldering, cool the chips and the substrate gradually to room temperature. Natural cooling in air is recommended to minimize stress in the solder joint.

CLEANING

All flux residues must be removed by using suitable electronic-grade vapor-cleaning solvents to eliminate contamination that could cause electrolytic surface corrosion. Good results can be obtained by using ultrasonic cleaning of the solvent. The choice of the proper system is depends upon many factors such as component mix, flux, and solder paste and assembly method. The ability of the cleaning system to remove flux residues and contamination from under the chips is very important.